

SP6019C Synchronous Rectifier Driver

DESCRIPTION

The fundamental of SP6019C synchronous rectifier (SR) driver IC is based on our U.S. patented methods that utilize the principle of "prediction" logic circuit. The IC deliberates previous cycle timing to control the SR in present cycle by "predictive" algorithm that makes adjustments to the turn-off time, in order to achieve maximum efficiency and avoid cross-conduction at the same time. SP6019C is specially suitable for Forward and DC/DC Module.

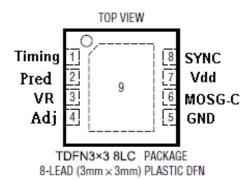
FEATURES

- Offers efficiency improvement over Schottky Diode (depends on drive configuration of the SR).
- Drives all Power MOSFET.
- Prediction gate timing control.
- Minimum MOSFET body diode conduction.
- Operating at high switching frequency.
- Synchronize to transformer secondary voltage waveform.
- Linear setting of timing function.
- TDFN3X3 8LC package design

APPLICATIONS

- Servers & workstations
- Storage area network power supplies
- Telecommunication converters
- Embedded systems
- Industrial & commercial systems using high current processors
- DC/DC Power Module

PIN CONFIGURATION (TDFN3X3 8LC)

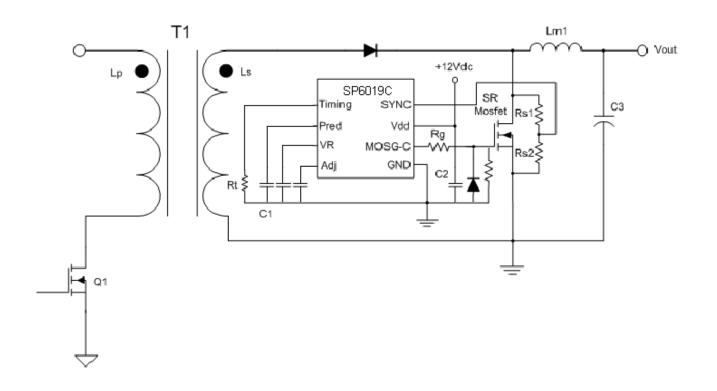


PART MARKING



SP6019C Synchronous Rectifier Driver

TYPICAL APPLCATION CIRCUIT

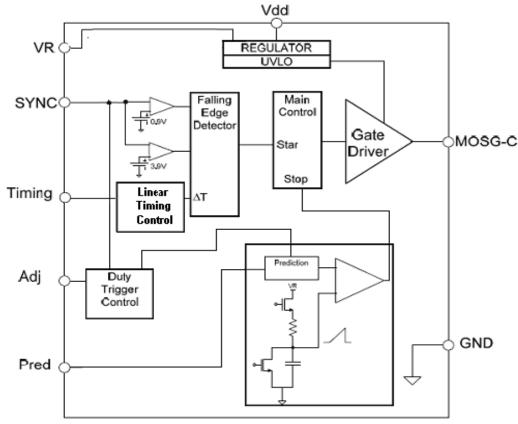


PIN DESCRIPTION

Pin	Symbol	Description	
1	Timing	Discontinuous current filter timing adjustment resistor connection.	
2	Pred	Capacitor to store previous cycle timing for SR MOSFET.	
3	VR	Voltage Regulator.	
4	Adj	Trigger point adjustment for Dynamic state.	
5	GND	Ground connection.	
6	MOSG-C	Catch MOSFET gate drive.	
7	Vdd	DC supply voltage.	
8	SYNC	Synchronized signal from the V _{DS} of SR MOSFET.	
9	GND	Ground, Exposed Pad	



BLOCK DIAGRAM



ORDERING INFORMATION

Part Number	Package	Part Marking
SP6019CTDN8RGB	TDFN3X3-8LC	SP6019C

X SP6019CTDN8RGB : Tape Reel ; Pb - Free ; Halogen - Free

ABSOULTE MAXIMUM RATINGS (TA=25°C, unless otherwise specified.)

The following ratings designate persistent limits beyond which damage to the device may occur.

Symbol	Parameter	Value	Unit
V_{dd}	DC Supply Voltage	16	V
I _{OUT}	Peak Source Current (Pulsed)	2.0	А
	Peak Sink Current (Pulsed)	2.0	А
P _D	Power Dissipation @ $T_A=85^{\circ}C$ (*)	1.8	W
TJ	Operating Junction Temperature Range	-40 to125	°C
T _{STG}	Storage Temperature Range	-40 to 150	°C
T _{LEAD}	Lead Soldering Temperature for 5 sec.	260	°C

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit		
Rojc	Thermal Resistance Junction – Case (*)	8	°C/W		
(*) The power dissipation and thermal resistance are evaluated under copper board mounted with free air conditions.					

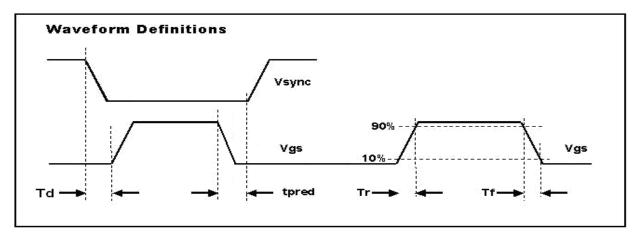


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ELECTRICAL CHARACTERISTICS

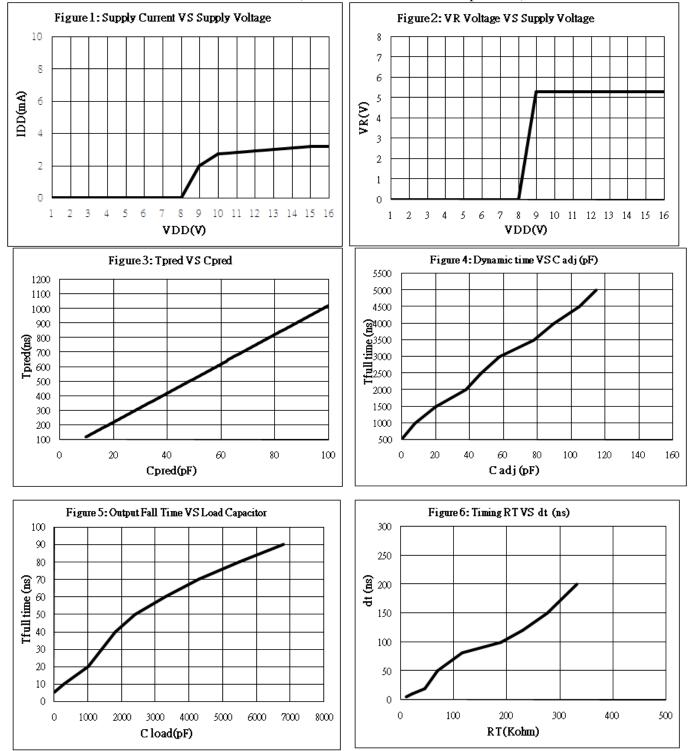
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
SUPPLY IN	PUT					
Idd	Supply current	V _{SYNC} =0V, Vdd on		3	4	mA
Vdd	Supply voltage	Idd peak $< 2A$			16	V
Vdd on	Enable voltage	<u>^</u>	7.8	8.2	8.6	V
Vdd	Enable voltage			0.25	0.5	v
hysteresis	-			0.25	0.5	v
Vovp	Over voltage protection		15.5	16.5	17.5	V
Vovp				0.3		v
hystersis				0.5		v
SYNC REFI	ERENCE (SYNC)					
Vshth	SYNC high threshold		3.5	3.9		V
Vslth	SYNC low threshold			0.9	1.2	V
Isync	SYNC input current				3	mA
Voltage Reg	ulator REFERENCE (VR)					
VR	voltage		5.2		5.4	V
Ivr	VR Output Current				50	mA
ON TIME D	UTY SETUP (PIN 6)			·		
Ton-time				26	32	us
MOSFET G	ATE DRIVER (MOSG-C)					
Voh	Output high voltage	Io = -200 mA	10.5	11.0		V
Vol	Output low voltage	Io = 200 mA		0.5	0.8	V
Td	Propagation delay	No load	25	50	155	ns
Tpred		No load		120		ns
Tr	Rise time	Load = 1nF(*)		10	25	ns
Tf	Fall time	Load = 1nF(*)		10	25	ns
Dynamic Pro	otect					
Dt	Dynamic variable	Pin 4 open		600		ns
Ton-min	MOSG-C on time	PWM adjusts time > Dt		0.5		us

(*) Tr & Tf are measured among 10% and 90% of starting and final voltage.





PERFORMANCE CHARACTERISTICS ($T_A=25^{\circ}C$, unless otherwise specified.)



*Fig. 1 : No Load ; No SYNC

*Fig. 3 : Frequency = 100 kHz

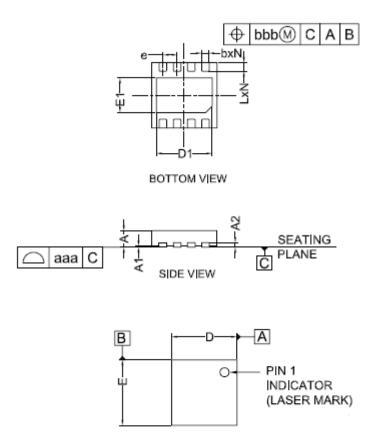
*Fig. $4 \sim 5$: Frequency = 65 kHz.

*Fig. 6 : The falling time of negative edge from 3.9V to 0.9V

2016/3/03 V.2



TDFN3X3- 8LC PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX	
А	0.70	0,75	0,80	
A1	0,00	0.02	0.05	
A2	A2 0.203			
b	0.30	0.35	0,40	
D	2,90	3.00	3.10	
D1	2.51	2.56	2.61	
E	2.90	3.00	3.10	
E1	1.55	1.60	1.65	
e	0.65BSC			
L	0.35	0,40	0.45	
N	8			
aaa	0.08			
bbb	0.10			

NOTES:

1.CONTROLLING DIMENSIONS ARE IN MILLIMETERS(ANGLES IN DEGREES). 2, COPLANARITY APPLIES TO THE EXPOSED PAD AS THE TERMINALS,



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